IPC ASSOCIATION ELECTRONIC	Material Composition Declaration © Copyright 2005. IPC, Bannockburn, Illinois. All rights reserved under both international and Pan-American copyright conventions.				This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with lower level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.											
1752-21.1					Form Type Distribute						erials and I	ials and Mfg Information				
Supplier	· Information															
Company	name*	Company unique ID			Ţ	Unique ID Authority					Respon	Response Date*				
onsemi												2025-0	2025-05-09			
Contact N	ame		Title - Contact			I	Phone - Contact*					Email	Email - Contact*			
Product-I	Env-Stewards		Product Enviro Compliance				NA					Produ	Product-Env-Stewards@onsemi.com			
Authorize	d Representative*		Title - Representative			I	Phone - Representative*					Email	Email - Representative*			
Product-I	Env-Stewards	Product Enviro Compliance				NA					Produ	Product-Env-Stewards@onsemi.com				
	Requester Item Number Mfr Item		n Number Mfr Item Name				Effective Da	ate V	/ersion	Manufacturing Site			Weight	t*	UOM	Unit Type
		FOD8332R2 SO16 LED 2.		SO16 LED 2.5A C	A GD T&R		2025-05-09			PBB	РВВ		417.10	1	mg	Each
Manufa	cturing Proccess Informa	tion								1			,			
	Terminal Plating / Grid Array Ma	Ferminal Base Alloy J-STD-020 MSI		L Rating	Peak Process Body		Body Tempe	y Temperature Max Time at Peak		ak Temper	Temperature Number of		of Reflow Cyc	les		
Matte Tin (Sn) - annealed			CU Alloy 1				260 C		3	0	seco	nds 3	3			
Comments																
evel 1 - m	aximum time at peak temperatu	re during sol	dering is 10-3	0 seconds												
or more	information regarding material	composition	please refer to	page 3												

RoHS Material Composition Declaration			Declaration Type *	Detail	ed						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).											
Please indicate whether any homogeneous material (as defined by the RoHS Directive, EU 2011/65/EU and implemented by the laws of the European Union member states) of the part identified on this form contains lead, mercury, cadmium, hexavalentchromium, polybrominated biphenyls and/or polybrominated diphenyl ethers (each a "RoHS restricted substance") in excess of the applicable quantity limit identified above. If a homogeneous material within the part contains a RoHS restricted substance inexcess of an applicable quantity limit, please indicate below which, if any, RoHS exemption you believe may apply. If the part is an assembly with lower level components, the declaration shall encompass all such components. Supplier certifies that it gathered the information it provides in this form using appropriate methods to ensure its accuracy and that such information is true and correct to the best of its knowledge and belief, as of the date that Supplier completes this form. Supplier acknowledges that Company will rely on this certification in determining the compliance of its products with European Union member state laws that implement the RoHS Directive. Company acknowledges that Supplier may have relied on information provided by others in completing this form, and that Supplier may not have independently verified such information. However, in situations where Supplier has not independently verified information provided by others, Supplier agrees that, at a minimum, its paragraph. If the Company and the Supplier have provided certifications regarding their contributions to the part, and those certifications are at least as comprehensive as the certification in this paragraph. If the Company and the Supplier have provided as part of that agreement, will be the sole and exclusivesource of the Supplier's liability and the Company's remedies for issues that arise regarding information the Supplier provides in this form. In the absence of such written agreement, the warranty rights and/or remedies of Supplier's Standard											
RoHS Declaration * 1 - Item	(s) does not contain RoHS restricted substar	nces per the definition above	Supplier A	cceptance *	Accepted						
Exemption: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions.											
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
		e "Accepted" on the Supplier Acceptance	drop-down. This will display the signature a	rea. Digitally sign t	the declaration (if required by the						

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	5.58	mg	Supplier	Silicon (Si)	7440-21-3		5.58	mg
Die Attach	1.336	mg	Supplier	Silver (Ag)	7440-22-4		1.07	mg
			Supplier	Phenolic Resin-2	54208-63-8		0.266	mg
Lead Frame	121.227	mg	Supplier	Silver (Ag)	7440-22-4		0.206	mg
			Supplier	Zinc (Zn)	7440-66-6		0.145	mg
			Supplier	Iron (Fe)	7439-89-6		2.84	mg
			Supplier	Copper (Cu)	7440-50-8		118.0001	mg
			Supplier	Phosphorus (P)	7723-14-0		0.0359	mg
Mold Compound-Black	286.449	mg	Supplier	2,6-dibromo-4-[1-(3-bromo-4-hydroxyphenyl)-1-methylethyl]phenol	6386-73-8		7.16	mg
			Supplier	Ortho Cresol Novolac Resin	29690-82-2		38.7001	mg
			В	Antimony Trioxide (Sb2O3)	1309-64-4		5.73	mg
			Supplier	Carbon Black (C)	1333-86-4		0.859	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		233.9999	mg
Plating	1.73	mg	Supplier	Tin (Sn)	7440-31-5		1.73	mg
Wire Bond - Au	0.779	mg	Supplier	Gold (Au)	7440-57-5		0.779	mg